



TSMC Recognizes Outstanding Suppliers at 2020 Supply Chain Management Forum

Hsinchu, Taiwan, R.O.C., Dec. 3, 2020 – TSMC (TWSE: 2330, NYSE: TSM) today held its 20th annual Supply Chain Management Forum, with sessions on spare parts, facilities, information technology, and advanced packaging, meeting in conjunction with the third Responsible Supply Chain Forum to discuss key topics for the semiconductor industry.

Due to the COVID-19 pandemic, the forum suspended the main session and award ceremony this year. However, under strict anti-pandemic measures, nearly 700 suppliers from the fields of equipment, materials, packaging, testing, facilities, IT systems and services, and environmental and waste management services attended the event, which emphasized corporate social responsibility, improvements to industrial safety, enhancement of parts supply management, strengthening information security, as well as the challenges and requirements of future manufacturing technologies. Since the Supply Chain Management and Responsible Supply Chain Forums were combined in 2019, the event has not only helped to raise the leading-edge technology capabilities of local suppliers, it has also raised their awareness of sustainability issues including energy conservation, carbon reduction, water saving, pollution prevention, and circular economy, partnering with TSMC to build a green supply chain.

“With the support of our suppliers, TSMC was able to lead the industry in volume production of 5-nanometer technology in 2020 and quickly improve yields despite the challenges of the global pandemic,” said J. K. Lin, Senior Vice President of Information Technology and Materials Management & Risk Management at TSMC. “Looking ahead, TSMC will continue building a responsible supply chain, and strengthen collaboration with supplier partners to improve our competitiveness and move towards the next generation’s 3-nanometer technology.”

TSMC also expressed its sincere appreciation to all suppliers at the forum, and will present its “Excellent Performance Award” to 15 outstanding equipment, facilities, materials, and IT service suppliers in recognition of their contributions.

The winners are as follows (in alphabetical order):

Applied Materials, Inc. – Excellent Technology Collaboration

Asahi Kasei Corporation - Excellent Technology Cooperation and Production Support in Litho Materials

ASML Holding N.V. – Excellent Technology Collaboration



Chang Chun Petrochemical Co., Ltd. - Green and Sustainability
DISCO Corporation – Excellent Production Support
International Business Machines Corporation - Excellent Production Support in Fab Automation
Lam Research Corporation – Excellent Technology Collaboration
SCREEN Semiconductor Solutions Co., Ltd. – Excellent Production Support
Shin-Etsu Handotai Co., Ltd. - Excellent Production Support in Silicon Wafer
SUMCO Corporation – Excellent Technology Collaboration and Production Support in Silicon Wafer
Sumitomo Heavy Industries Ion Technology Co., Ltd. – Excellent Production Support
Taiwan Puritic Corp. – Excellent Production Support in New Fab Construction
TECHNOPROBE S.P.A – Excellent Production Support
Tokyo Electron Limited – Excellent Production Support
United Integrated Services Co., Ltd. - Excellent Production Support in New Fab Construction

About TSMC

TSMC pioneered the pure-play foundry business model when it was founded in 1987, and has been the world’s largest dedicated semiconductor foundry ever since. The Company supports a thriving ecosystem of global customers and partners with the industry’s leading process technologies and portfolio of design enablement solutions to unleash innovation for the global semiconductor industry. With global operations spanning Asia, Europe, and North America, TSMC serves as a committed corporate citizen around the world.

TSMC deployed 272 distinct process technologies, and manufactured 10,761 products for 499 customers in 2019 by providing broadest range of advanced, specialty and advanced packaging technology services. TSMC is the first foundry to provide 5-nanometer production capabilities, the most advanced semiconductor process technology available in the world. The Company is headquartered in Hsinchu, Taiwan. For more information please visit <https://www.tsmc.com>.

#

TSMC Spokesperson:

Wendell Huang
Vice President and CFO
Tel: 886-3-505-5901

Media Contacts:

Nina Kao
Head of Public Relations
Tel: 886-3-563-6688 ext.7125036
Mobile: 886-988-239-163
E-Mail: nina_kao@tsmc.com

Michael Kramer
Public Relations
Tel: 886-3-563-6688 ext. 7125031
Mobile: 886-988-931-352
E-Mail: pdkramer@tsmc.com